

Product Summary

Device	BVDSS	Rds(on) Max	I _D Max T _A = +25°C
Q1	30V	30mΩ @ V _{GS} = 10V	5.3A
N-Channel	307	42mΩ @ V _{GS} = 4.5V	4.5A
Q2	-30V	70mΩ @ VGs = -10V	-3.4A
P-Channel	-30 V	100mΩ @ V _{GS} = -4.5V	-2.9A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Body control electronics

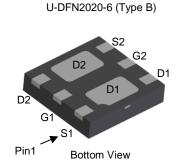
- Power management functions
- **DC-DC** converters

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed •
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2) •
- Halogen and Antimony Free. "Green" Device (Note 3) .
- For automotive applications requiring specific change control (i.e. parts gualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: U-DFN2020-6 •
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)



D2 **D1** G2 **G1 S2 S1**

Internal Schematic

Ordering Information (Note 4)

Part Number	Baakaga	Pa	Packing		
Fart Number	Package	Qty.	Carrier		
DMC3032LFDB-7	U-DFN2020-6 (Type B)	3,000	Tape & Reel		
DMC3032LFDB-13	U-DFN2020-6 (Type B)	10,000	Tape & Reel		

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. Notes:

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



BH = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 2 = 2022) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key												
Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	1	2	3	4	5	6	7	8	9	0	1	2
Week	1-26			27-52			53					
Code	A-Z				a-z			Z				
Internal Code	Sun Mon			Tue	w	ed	Thu		Fri		Sat	
Code	Т		U		V	V	V	Х		Y		Z

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Unit
Drain-Source Voltage			Vdss	30	-30	V
Gate-Source Voltage			Vgss	±20	±20	V
Continuous Drain Current (Note 5) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +75°C	ID	5.3 4.2	-3.4 -2.7	А
Maximum Continuous Body Diode Forward Current (Note 5)			ls	1.6	-1.2	А
Pulsed Body Diode Forward Current (370µs Pu	lse, Duty (Cycle = 1%)	lsм	20	-20	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			Ідм	20	-20	А
Avalanche Current (Note 6) L = 0.1mH			I _{AS}	12	-14	А
Avalanche Energy (Note 6) L = 0.1mH			Eas	10	10	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 7)		PD	0.8	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	R _{θJA}	149	°C/W
Total Power Dissipation (Note 5)		PD	1.28	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	98	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

6. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.

7. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



Electrical Characteristics Q1 N-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)	0,		• 76		•	
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	—	V	Vgs = 0V, ID = 250µA
Zero Gate Voltage Drain Current TJ = +25°C	IDSS	—	—	1.0	μA	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	VGS(TH)	1.0	—	2.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance	Bacton	-	24	30	mΩ	Vgs = 10V, ID = 5.8A
Static Drain-Source On-Resistance	Rds(on)	_	30	42	11152	VGS = 4.5V, ID = 4.8A
Diode Forward Voltage	V _{SD}		0.7	1.2	V	$V_{GS} = 0V, I_S = 1A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	_	500	—	pF	
Output Capacitance	Coss		52	—	pF	VDS = 15V, VGS = 0V f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	44	—	pF	1 - 1.00012
Gate Resistance	Rg		2.3	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (VGS = 4.5V)	Qg	_	5.0	—	nC	
Total Gate Charge (V _{GS} = 10V)	Qg		10.6	—	nC	V _{DS} = 15V, I _D = 5.8A
Gate-Source Charge	Q _{gs}		1.3	—	nC	VDS = 15V, ID = 5.6A
Gate-Drain Charge	Q _{gd}		1.8	—	nC	
Turn-On Delay Time	t _{D(ON)}		2.2	—	ns	
Turn-On Rise Time	tR		2.6	—	ns	V _{DD} = 15V, V _{GS} = 10V
Turn-Off Delay Time	tD(OFF)		9.7	—	ns	$R_L = 2.6\Omega, R_G = 3\Omega$
Turn-Off Fall Time	tF	_	2.0	—	ns]

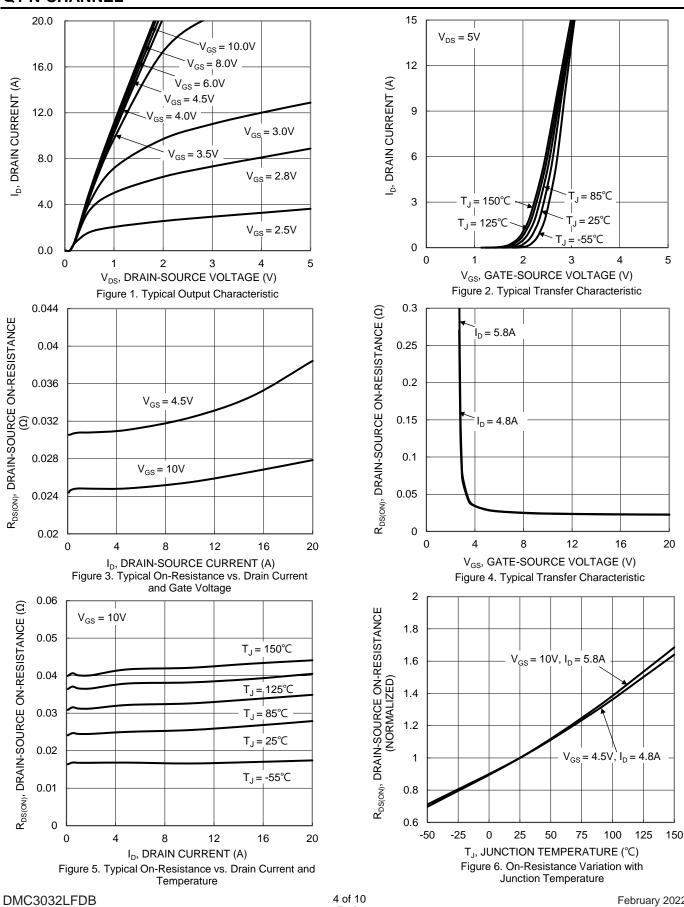
Electrical Characteristics Q2 P-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)				•		÷
Drain-Source Breakdown Voltage	BV _{DSS}	-30	—	—	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	—	—	-1.0	μA	V _{DS} = -30V, V _{GS} = 0V
Gate-Source Leakage	lgss	—	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	Vgs(th)	-1.0	—	-2.1	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$
Statia Drain Source On Desistance	Deserve	—	53	70	mΩ	V _{GS} = -10V, I _D = -3.8A
Static Drain-Source On-Resistance	RDS(ON)	—	75	100	11122	V _{GS} = -4.5V, I _D = -3.0A
Diode Forward Voltage	Vsd	—	-0.8	-1.2	V	VGS = 0V, IS = -2.7A
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	-	336	-	pF	
Output Capacitance	Coss	—	70	—	pF	VDS = -25V, VGS = 0V f = 1.0MHz
Reverse Transfer Capacitance	Crss	—	49	—	pF	1 = 1.000112
Gate Resistance	Rg	—	4.6	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	—	4.0	—	nC	
Total Gate Charge (VGS = -10V)	Qg	—	7.8	—	nC	
Gate-Source Charge	Qgs	_	1.0	—	nC	$V_{DS} = -15V, I_D = -3.8A$
Gate-Drain Charge	Qgd	—	2.5	—	nC	7
Turn-On Delay Time	t _{D(ON)}	_	6.0	—	ns	
Turn-On Rise Time	tR	_	5.0	—	ns	V _{DD} = -15V, V _{GS} = -10V
Turn-Off Delay Time	tD(OFF)	_	17.6	—	ns	ID = -1A, R _G = 6Ω
Turn-Off Fall Time	tF		9.5	—	ns	7

Notes: 8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.



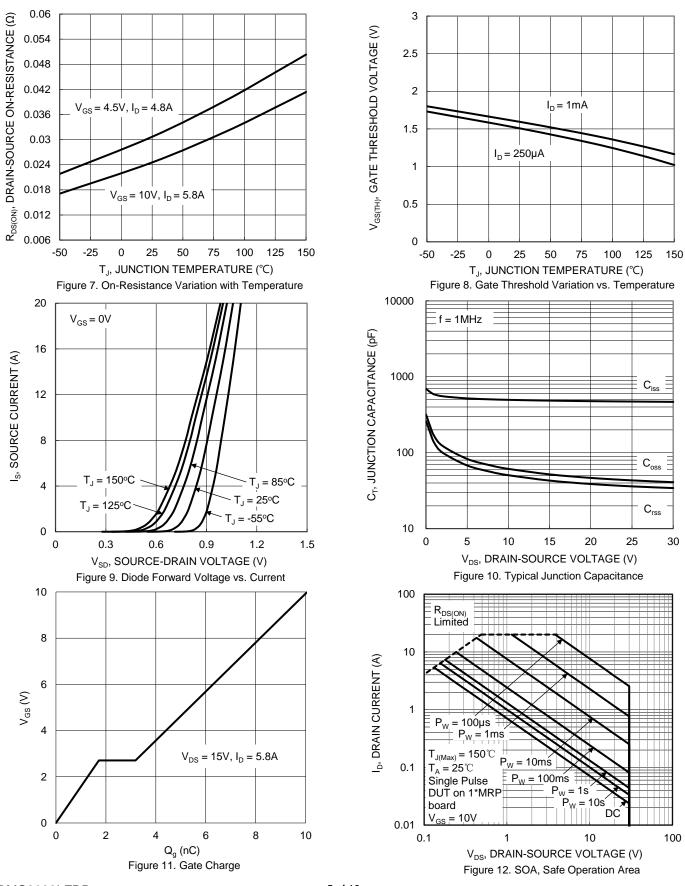
Q1 N-CHANNEL



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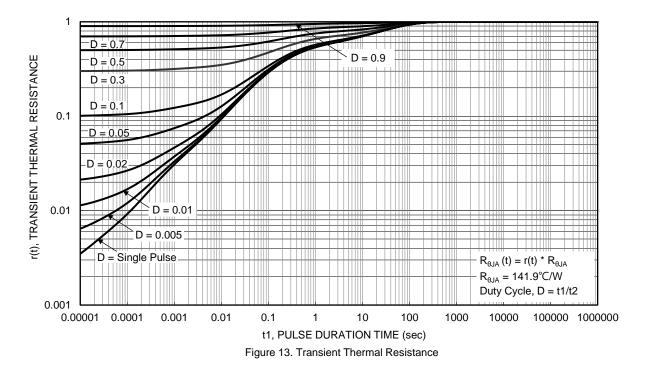
Q1 N-CHANNEL (continued)



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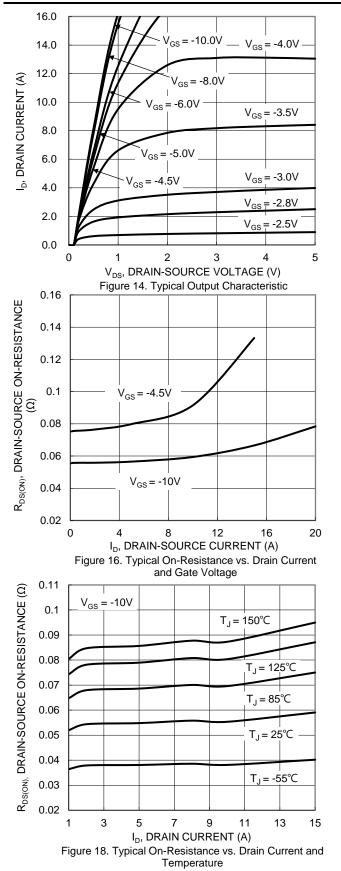


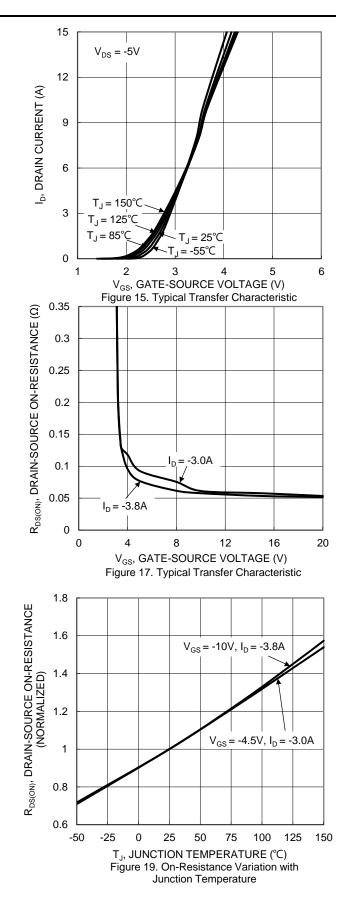
Q1 N-CHANNEL (continued)





Q2 P-CHANNEL

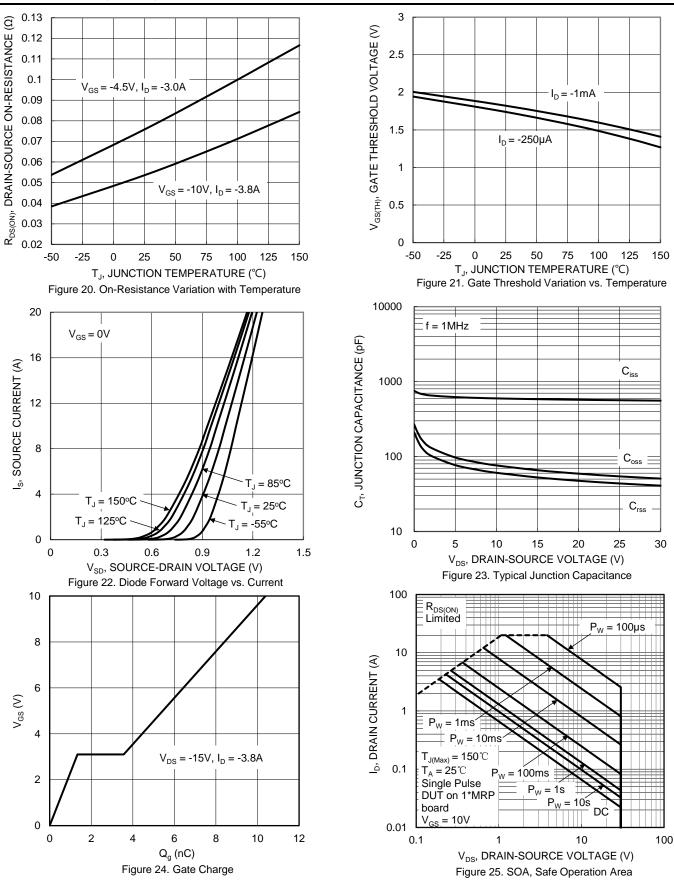




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Q2 P-CHANNEL (continued)



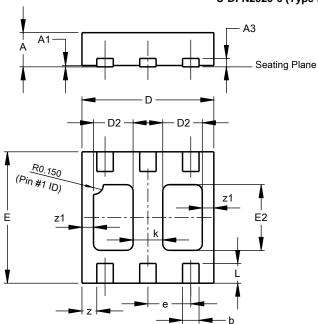
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Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

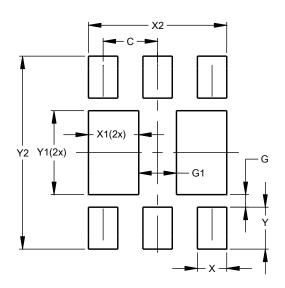


	U-DFN2020-6 Type B								
Dim	Min								
Α	0.545	0.605	0.575						
A1	0.00	0.05	0.02						
A3	-	-	0.13						
b	0.20	0.30	0.25						
D	1.95	2.075	2.00						
D2	0.50	0.70	0.60						
е	-	-	0.65						
Е	1.95	2.075	2.00						
E2	0.90	1.10	1.00						
k	-	-	0.45						
L	0.25	0.35	0.30						
z	-	-	0.225						
z1	-	-	0.175						
All	Dimens	ions in	mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type B)



Dimensions	Value (in mm)
С	0.650
G	0.150
G1	0.450
Х	0.350
X1	0.600
X2	1.650
Y	0.500
Y1	1.000
Y2	2.300

U-DFN2020-6 (Type B)



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